

SVENSK STANDARD SS-EN IEC 61800-3

FastställdUtgåvaSidaAnsvarig kommitté2018-10-1731 (1+126)SEK TK 22

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Varvtalsstyrda elektriska drivsystem – Del 3: EMC-fordringar och speciella provningsmetoder

Adjustable speed electrical power drive systems – Part 3: EMC requirements and specific test methods

Som svensk standard gäller europastandarden EN IEC 61800-3:2018. Den svenska standarden innehåller den officiella engelska språkversionen av EN IEC 61800-3:2018.

Nationellt förord

Europastandarden EN IEC 61800-3:2018

består av:

- europastandardens ikraftsättningsdokument, utarbetat inom CENELEC
- IEC 61800-3, Third edition, 2017 Adjustable speed electrical power drive systems -Part 3: EMC requirements and specific test methods

utarbetad inom International Electrotechnical Commission, IEC.

EN från CENELEC som är identiska med motsvarande IEC-standarder och som görs tillgängliga för nationalkommittéerna efter den 1 januari 2018 får en beteckning som inleds med EN IEC istället för som tidigare bara EN.

Tidigare fastställd svensk standard SS-EN 61800-3, utgåva 2, 2005 och SS-EN 61800-3/A1, utgåva 1, 2012, gäller ej fr o m 2021-07-09.

ICS 29.200.00; 33.100.01

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Adjustable speed electrical power drive systems - Part 3: EMC requirements and specific test methods (IEC 61800-3:2017)

Entraînements électriques de puissance à vitesse variable -Partie 3: Exigences de CEM et méthodes d'essais spécifiques (IEC 61800-3:2017) Drehzahlveränderbare elektrische Antriebssysteme - Teil 3: EMV-Anforderungen einschließlich spezieller Prüfverfahren (IEC 61800-3:2017)

This European Standard was approved by CENELEC on 2018-07-09. CENELEC members are bound to comply with the CEN/CENELEC Internal Regulations which stipulate the conditions for giving this European Standard the status of a national standard without any alteration.

Up-to-date lists and bibliographical references concerning such national standards may be obtained on application to the CEN-CENELEC Management Centre or to any CENELEC member.

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European foreword

The text of document 22G/347/FDIS, future edition 3 of IEC 61800-3, prepared by SC 22G "Adjustable speed electric drive systems incorporating semiconductor power converters" of IEC/TC 22 "Power electronic systems and equipment" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN IEC 61800-3:2018.

The following dates are fixed:

- latest date by which the document has to be implemented at national (dop) 2019-04-09 level by publication of an identical national standard or by endorsement
- latest date by which the national standards conflicting with the (dow) 2021-07-09 document have to be withdrawn

This document supersedes EN 61800-3:2004 and EN 61800-3:2004/A1:2012.

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Endorsement notice

The text of the International Standard IEC 61800-3:2017 was approved by CENELEC as a European Standard without any modification.

In the official version, for Bibliography, the following notes have to be added for the standards indicated:

IEC 60038:2009	NOTE	Harmonized as EN 60038:2011 (modified).
IEC 60065	NOTE	Harmonized as EN 60065.
IEC 60146-1-3:1991	NOTE	Harmonized as EN 60146-1-3:1993 (not modified).
IEC 60146-2:1999	NOTE	Harmonized as EN 60146-2:2000 (not modified).
IEC 60364-1:2005	NOTE	Harmonized as HD 60364-1:2008 (modified).
IEC 60664-1:2007	NOTE	Harmonized as HD 60664-1:2007 (not modified).
IEC 61000-2-12:2003	NOTE	Harmonized as EN 61000-2-12:2003 (not modified).
IEC 61000-4 (series)	NOTE	Harmonized as EN 61000-4 (series).
IEC 61000-4-7:2002	NOTE	Harmonized as EN 61000-4-7:2002 (not modified).
IEC 61000-4-9:2016	NOTE	Harmonized as EN 61000-4-9:2016 (not modified).
IEC 61000-4-10:2016	NOTE	Harmonized as EN 61000-4-10:2017 (not modified).
IEC 61000-6-1:2016	NOTE	Harmonized as EN 61000-6-1:2018 (not modified).
IEC 61000-6-2:2016	NOTE	Harmonized as EN 61000-6-2:2017 (not modified).
IEC 61000-6-4:2006	NOTE	Harmonized as EN 61000-6-4:2007 (not modified).

IEC 61000-6-5:2015	NOTE	Harmonized as EN 61000-6-5:2015 (not modified).
IEC 61400-21:2008	NOTE	Harmonized as EN 61400-21:2008 (not modified).
IEC 61557-8:2014	NOTE	Harmonized as EN 61557-8:2015 (not modified).
IEC 61557-9	NOTE	Harmonized as EN 61557-9.
IEC 61800-1:1997	NOTE	Harmonized as EN 61800-1:1998 (not modified).
IEC 61800-2:2015	NOTE	Harmonized as EN 61800-2:2015 (not modified).
IEC 61800-4:2002	NOTE	Harmonized as EN 61800-4:2003 (not modified).
IEC 61800-5-1:2007	NOTE	Harmonized as EN 61800-5-1:2007 (not modified).
CISPR 14-1:2016	NOTE	Harmonized as EN 55014-1:2017 (not modified).
CISPR 16-2-1:2014	NOTE	Harmonized as EN 55016-2-1:2014 (not modified).
CISPR 16-2-3:2016	NOTE	Harmonized as EN 55016-2-3:2017 (not modified).

Annex ZA

(normative)

Normative references to international publications with their corresponding European publications

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE 1 Where an International Publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

NOTE 2 Up-to-date information on the latest versions of the European Standards listed in this annex is available here: www.cenelec.eu.

Publication	Year	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 60146-1-1	2009	Semiconductor converters - General requirements and line commutated converters Part 1-1: Specification of basic requirements	EN 60146-1-1	2010
IEC 61000-2-2	2002	Electromagnetic compatibility (EMC) Part 2-2: Environment - Compatibility levels for low-frequency conducted disturbances and signalling in public low-voltage power supply systems	EN 61000-2-2	2002
IEC 61000-2-4	2002	Electromagnetic compatibility (EMC) Part 2-4: Environment - Compatibility levels in industrial plants for low-frequency conducted disturbances	EN 61000-2-4	2002
IEC 61000-3-2	2014	Electromagnetic compatibility (EMC) - Part 3-2: Limits - Limits for harmonic current emissions (equipment input current - 16 A per phase)	EN 61000-3-2	2014
IEC 61000-3-3	2013	Electromagnetic compatibility (EMC) - Part 3-3: Limits - Limitation of voltage changes, voltage fluctuations and flicker in public low-voltage supply systems, for equipment with rated current - 16 A per phase and not subject to conditional connection	EN 61000-3-3	2013
IEC 61000-3-11	2000	Electromagnetic compatibility (EMC) Part 3-11: Limits - Limitation of voltage changes, voltage fluctuations and flicker in public low-voltage supply systems - Equipment with rated current <= 75 A and subject to conditional connection	EN 61000-3-11	2000

IEC 61000-3-12	2011	Electromagnetic compatibility (EMC) Part 3-12: Limits - Limits for harmonic currents produced by equipment connected to public low-voltage systems with input current > 16 A and <= 75 A per phase	EN 61000-3-12	2011
IEC 61000-4-2	2008	Electromagnetic compatibility (EMC) Part 4-2: Testing and measurement techniques - Electrostatic discharge immunity test	EN 61000-4-2	2009
IEC 61000-4-3	2006	Electromagnetic compatibility (EMC) Part 4-3: Testing and measurement techniques - Radiated, radio-frequency, electromagnetic field immunity test	EN 61000-4-3	2006
IEC 61000-4-4	2012	Electromagnetic compatibility (EMC) Part 4-4: Testing and measurement techniques - Electrical fast transient/burst immunity test	EN 61000-4-4	2012
IEC 61000-4-5	2014	Electromagnetic compatibility (EMC) - Part 4-5: Testing and measurement techniques - Surge immunity test	EN 61000-4-5	2014
IEC 61000-4-6	2013	Electromagnetic compatibility (EMC) Part 4-6: Testing and measurement techniques - Immunity to conducted disturbances, induced by radio-frequency fields	EN 61000-4-6	2014
IEC 61000-4-8	2009	Electromagnetic compatibility (EMC) Part 4-8: Testing and measurement techniques - Power frequency magnetic field immunity test	EN 61000-4-8	2010
IEC 61000-4-11	2004	Electromagnetic compatibility (EMC) Part 4-11: Testing and measurement techniques - Voltage dips, short interruptions and voltage variations immunity tests	EN 61000-4-11	2004
IEC 61000-4-13	2002	Electromagnetic compatibility (EMC) Part 4-13: Testing and measurement techniques - Harmonics and interharmonics including mains signaling at a.c. power port, low frequency immunity tests	EN 61000-4-13	2002
IEC 61000-4-34	2005	Electromagnetic compatibility (EMC) Part 4-34: Testing and measurement techniques - Voltage dips, short interruptions and voltage variations immunity tests for equipment with input current more than 16 A per phase	EN 61000-4-34	2007
CISPR 11 (mod)	2015	Industrial, scientific and medical equipment - Radio-frequency disturbance characteristics - Limits and methods of measurement	EN 55011	2016
+ A1	2016		+ A1	2017

EN IEC 61800-3:2018 (E)

CISPR 16-1-2	2014	Specification for radio disturbance and immunity measuring apparatus and methods - Part 1-2: Radio disturbance and immunity measuring apparatus - Coupling devices for conducted disturbance measurements	EN 55016-1-2	2014
CISPR 16-1-4	2010	Specification for radio disturbance and immunity measuring apparatus and methods Part 1-4: Radio disturbance and immunity measuring apparatus - Antennas and test sites for radiated disturbance measurements	EN 55016-1-4	2010
CISPR 22	-	Information technology equipment - Radio disturbance characteristics - Limits and methods of measurement	-	-
CISPR 32	2015	Electromagnetic compatibility of multimedia equipment - Emission requirements	EN 55032	2015

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

ADJUSTABLE SPEED ELECTRICAL POWER DRIVE SYSTEMS –

Part 3: EMC requirements and specific test methods

FOREWORD

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International Standard IEC 61800-3 has been prepared by subcommittee 22G: Adjustable speed electric drive systems incorporating semiconductor power converters, of IEC technical committee 22: Power electronic systems and equipment.

This third edition cancels and replaces the second edition published in 2004 and Amendment 1:2011. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) clarification of requirements for the test report, particularly when a number of alternative test methods exist;
- b) introduction of a more detailed test setup for radiated emission measurements, along with the introduction of a 3 m measurement distance for small size equipment;
- c) general updates in the informative annexes.

The text of this standard is based on the following documents:

FDIS	Report on voting
22G/347/FDIS	22G/350/RVD

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2, and with IEC Guide 107.

A list of all parts in the IEC 61800 series, published under the general title *Adjustable speed electrical power drive systems*, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under "http://webstore.iec.ch" in the data related to the specific document. At this date, the document will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

IMPORTANT – The "colour inside" logo on the cover page of this publication indicates that it contains colours which are considered to be useful for the correct understanding of its contents. Users should therefore print this publication using a colour printer.

ADJUSTABLE SPEED ELECTRICAL POWER DRIVE SYSTEMS –

Part 3: EMC requirements and specific test methods

1 Scope

This part of IEC 61800 specifies electromagnetic compatibility (EMC) requirements for power drive systems (PDSs, defined in 3.1). These are adjustable speed AC or DC motor drives. Requirements are stated for PDSs with converter input and/or output voltages (line-to-line voltage), up to 35 kV AC RMS.

PDSs covered by this document are those installed in residential, commercial and industrial locations with the exception of traction applications, and electric vehicles. PDSs can be connected to either industrial or public power distribution networks. Industrial networks are supplied by a dedicated distribution transformer, which is usually adjacent to or inside the industrial location, and supplies only industrial customers. Industrial networks can also be supplied by their own electric generating equipment. On the other hand, PDSs can be directly connected to low-voltage public mains networks which also supply residential premises, and in which the neutral is generally earthed (grounded).

The scope of this part of IEC 61800, related to EMC, includes a broad range of PDSs from a few hundred watts to hundreds of megawatts. PDSs are often included in a larger system. The system aspect is not covered by this document but guidance is provided in the informative annexes.

The requirements have been selected so as to ensure EMC for PDSs at residential, commercial and industrial locations. The requirements cannot, however, cover extreme cases which can occur with an extremely low probability. Changes in the EMC behaviour of a PDS, as a result of fault conditions, are not taken into account.

The object of this document is to define the limits and test methods for a PDS according to its intended use. This document includes immunity requirements and requirements for electromagnetic emissions.

NOTE 1 Emission can cause interference in other electronic equipment (for example radio receivers, measuring and computing devices). Immunity is meant to protect the equipment from continuous and transient conducted and radiated disturbances including electrostatic discharges. The emission and immunity requirements are balanced against each other and against the actual environment of the PDS.

This document defines the minimum EMC requirements for a PDS.

Immunity requirements are given according to the environment classification. Low-frequency emission requirements are given according to the nature of the supply network. High-frequency emission requirements are given according to four categories of intended use, which cover both environment and bringing into operation.

As a product standard, this document can be used for the assessment of PDS. It can also be used for the assessment of complete drive modules (CDM) or basic drive modules (BDM) (see 3.1), which can be marketed separately.

This document contains

• conformity assessment requirements for products to be placed on the market, and

 recommended engineering practice (see 6.5) for cases where high frequency emissions cannot be measured before the equipment is placed on the market (such PDSs are defined in 3.2.7 as category C4).

NOTE 2 The first edition of IEC 61800-3 identified that the intended use could require engineering for putting into service. This was done by the "restricted distribution mode". Equipment formerly identified under "restricted distribution mode" is now covered by categories C2 and C4 (see 3.2).

This document is intended as a complete EMC product standard for the EMC conformity assessment of products of categories C1, C2 and C3, when placing them on the market (see definitions 3.2.4 to 3.2.6).

Radio frequency emission of equipment of category C4 is only assessed when it is installed in its intended location. It is therefore treated as a fixed installation, for which this document gives rules of engineering practice in 6.5 and Annex E, although it gives no defined emission limits (except in case of complaint).

This document does not specify any safety requirements for the equipment such as protection against electric shocks, insulation co-ordination and related dielectric tests, unsafe operation, or unsafe consequences of a failure. It also does not cover safety and functional safety implications of electromagnetic phenomena.

In special cases, when highly susceptible apparatus is being used in proximity, additional mitigation measures can have to be employed to reduce the electromagnetic emission further below the specified levels or additional countermeasures can have to be employed to increase the immunity of the highly susceptible apparatus.

As an EMC product standard for PDSs, this document takes precedence over all aspects of the generic standards, and no additional EMC tests are performed. If a PDS is included as part of equipment covered by a separate EMC product standard, the EMC standard of the complete equipment applies.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60146-1-1:2009, Semiconductor convertors – General requirements and line commutated convertors – Part 1-1: Specifications of basic requirements

IEC 61000-2-2:2002, Electromagnetic compatibility (EMC) – Part 2-2: Environment – Compatibility levels for low-frequency conducted disturbances and signalling in public low-voltage power supply systems

IEC 61000-2-4:2002, Electromagnetic compatibility (EMC) – Part 2-4: Environment – Compatibility levels in industrial plants for low-frequency conducted disturbances

IEC 61000-3-2:2014, Electromagnetic compatibility (EMC) – Part 3-2: Limits – Limits for harmonic current emissions (equipment input current \leq 16 A per phase)

IEC 61000-3-3:2013, Electromagnetic compatibility (EMC) – Part 3-3: Limits – Limitation of voltage changes, voltage fluctuations and flicker in public low-voltage supply systems, for equipment with rated current \leq 16 A per phase and not subject to conditional connection

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IEC 61000-3-11:2000, Electromagnetic compatibility (EMC) – Part 3-11: Limits – Limitation of voltage changes, voltage fluctuations and flicker in public low-voltage supply systems – Equipment with rated current \leq 75 A and subject to conditional connection

IEC 61000-3-12: 2011, Electromagnetic compatibility (EMC) – Part 3-12: Limits – Limits for harmonic currents produced by equipment connected to public low-voltage systems with input current > 16 A and \leq 75 A per phase

IEC 61000-4-2:2008, Electromagnetic compatibility (EMC) – Part 4-2: Testing and measurement techniques – Electrostatic discharge immunity test

IEC 61000-4-3:2006, *Electromagnetic compatibility (EMC) – Part 4-3: Testing and measurement techniques – Radiated, radio-frequency, electromagnetic field immunity test*

IEC 61000-4-4:2012, Electromagnetic compatibility (EMC) – Part 4-4: Testing and measurement techniques – Electrical fast transient/burst immunity test

IEC 61000-4-5:2014, Electromagnetic compatibility (EMC) – Part 4-5: Testing and measurement techniques – Surge immunity test

IEC 61000-4-6:2013, Electromagnetic compatibility (EMC) – Part 4-6: Testing and measurement techniques – Immunity to conducted disturbances, induced by radio-frequency fields

IEC 61000-4-8:2009, Electromagnetic compatibility (EMC) – Part 4-8: Testing and measurement techniques – Power frequency magnetic field immunity test

IEC 61000-4-11:2004, Electromagnetic compatibility (EMC) – Part 4-11: Testing and measurement techniques – Voltage dips, short interruptions and voltage variations immunity tests

IEC 61000-4-13:2002, Electromagnetic compatibility (EMC) – Part 4-13: Testing and measurement techniques – Harmonics and interharmonics including mains signalling at a.c. power port, low frequency immunity tests

IEC 61000-4-34:2005, Electromagnetic compatibility (EMC) – Part 4-34: Testing and measurement techniques – Voltage dips, short interruptions and voltage variations immunity tests for equipment with input current more than 16 A per phase

CISPR 11:2015, Industrial, scientific and medical equipment – Radio-frequency disturbance characteristics – Limits and methods of measurement CISPR 11:2015/AMD1:2016

CISPR 16-1-2:2014, Specification for radio disturbance and immunity measuring apparatus and methods – Part 1-2: Radio disturbance and immunity measuring apparatus – Coupling devices for conducted disturbance measurements

CISPR 16-1-4:2010, Specification for radio disturbance and immunity measuring apparatus and methods – Part 1-4: Radio disturbance and immunity measuring apparatus – Antennas and test sites for radiated disturbance measurements

CISPR 22, Information technology equipment – Radio disturbance characteristics – Limits and methods of measurement

CISPR 32:2015, Electromagnetic compatibility of multimedia equipment – Emission requirements